

多層片式陶瓷電容器

MULTILAYER CHIP CERAMIC CAPACITOR

■ 通用型Y5V片容

通用型Y5V片容属于II类低频电容器，其电容量受温度、电压、时间变化大。

● 特性

- * 在-25°C ~ 85°C 工作范围内，其温度特性为+30%，-80%。
- * 叠层独石结构，具有高可靠性。
- * 优良的可焊性和耐焊性，适用于回流焊和波峰焊。

● 應用

适用于各种滤波线路。

● 产品规格型号表示方法

0805 F 104 M 500 N T
 ① ② ③ ④ ⑤ ⑥ ⑦

①尺寸		
型号	英制(英寸)	公制(毫米)
0402	0.04 × 0.02	1.00 × 0.50
0603	0.06 × 0.03	1.60 × 0.80
0805	0.08 × 0.05	2.00 × 1.25
1206	0.12 × 0.06	3.20 × 1.60

②介質種類	
代碼	介質材料
F	Y5V

③標稱電容量(PF)	
表示方式	實際值
102	10×10^2
103	10×10^3
104	10×10^4

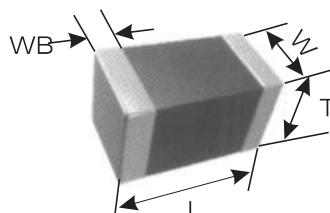
④誤差級別	
代碼	誤差
M	$\pm 20\%$
Z	$+80\%$ -20%

⑤工作電壓	
表示方法	實際電壓
6R3	6.3V
100	10V
250	25V
500	50V

⑥端頭類別	
表示方法	端頭材料
S	純銀端頭
C	純銅端頭
N	三層電鍍端頭 (銀或銅層/鎳層/錫層)

⑦包裝方式	
表示方法	包裝
無標記	袋裝散包裝
T	編帶包裝
B	塑料盒散包裝

● 外形尺寸



規格型號		尺寸(mm)			
英制表示	公制表示	L	W	T	WB
0402	1005	1.00 ± 0.05	0.50 ± 0.05	0.50 ± 0.05	0.25 ± 0.10
0603	1608	1.60 ± 0.10	0.80 ± 0.10	0.80 ± 0.10	0.30 ± 0.10
0805	2012	2.00 ± 0.20	1.25 ± 0.20	0.80 ± 0.10 1.00 ± 0.10 1.25 ± 0.20	0.50 ± 0.25
1206	3216	3.20 ± 0.30	1.60 ± 0.20	0.80 ± 0.10 1.00 ± 0.10 1.25 ± 0.20	0.50 ± 0.25



■ Y5V MLCC for General-use

Y5V MLCC for General-use is class II low frequency capacitor, its capacitance will change a lot along with the temperature,voltage,time.

• Features

- * Its operating temperature is -25°C~85°C,within the range, the temperature coefficient is +30%, -80%.
- * It has multi-layer monolithic structure, has high reliability.
- * It has good solderability and soldering resistance, suitable for flow soldering/reflow soldering.

• Applications

It is suitable for all kinds of filter circuits.

• Product Part Number Expression

0805	F	104	M	500	N	T
①	②	③	④	⑤	⑥	⑦

①Dimensions		
Type	British (Inch)	Metric (mm)
0402	0.04×0.02	1.00×0.50
0603	0.06×0.03	1.60×0.80
0805	0.08×0.05	2.00×1.25
1206	0.12×0.06	3.20×1.60

②Dielectric Type	
Code	Dielectric
F	Y5V

③Normal Capacitance(PF)	
Expression Method	Actual Value
102	10×10^2
103	10×10^3
104	10×10^4

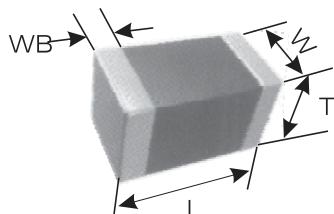
④Capacitance Tolerance	
Code	Tolerance
M	$\pm 20\%$
Z	+80% -20%

⑤Rated Voltage	
Expression Method	Actual Value
250	25V
500	50V
101	100V
201	200V

⑥Termination Type	
Expression Method	Termination Material
S	Pure Silver
C	Pure Copper
N	Three Layers Plating Terminal (Silver or Copper layer/ Nickel layer /Tin layer)

⑦Package Method	
Expression Method	Packaging
No Mark	Bulk Packaging in a Bag
T	Taping Packaging
B	Bulk Plastic Box Packaging

• Outside Dimension



Type		Dimension (mm)			
British expression	Metric expression	L	W	T	WB
0402	1005	1.00 ± 0.05	0.50 ± 0.05	0.50 ± 0.05	0.25 ± 0.10
0603	1608	1.60 ± 0.10	0.80 ± 0.10	0.80 ± 0.10	0.30 ± 0.10
0805	2012	2.00 ± 0.20	1.25 ± 0.20	0.80 ± 0.10 1.00 ± 0.10 1.25 ± 0.20	0.50 ± 0.25
1206	3216	3.20 ± 0.30	1.60 ± 0.20	0.80 ± 0.10 1.00 ± 0.10 1.25 ± 0.20	0.50 ± 0.25

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- 電容量範圍

項目	通用型Y5V片容																			
	0402				0603				0805				1206							
尺寸	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	50V
工作電壓	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	50V
電容量																				
1000PF																				
1.5nF																				
2.2nF																				
3.3nF																				
4.7nF																				
6.8nF																				
10nF																				
12nF																				
15nF																				
22nF																				
27nF																				
33nF																				
39nF																				
47nF																				
56nF																				
68nF																				
100nF																				
150nF																				
220nF																				
270nF																				
330nF																				
470nF																				
680nF																				
1 μ F																				
2.2 μ F																				
4.7 μ F																				
10 μ F																				
22 μ F																				
33 μ F																				
47 μ F																				
100 μ F																				



- Capacitance Range

Item	Y5V MLCC for General-use																			
Dimension	0402				0603				0805				1206							
Rated Volatage	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	50V
Capacitance																				
1000PF																				
1.5nF																				
2.2nF																				
3.3nF																				
4.7nF																				
6.8nF																				
10nF																				
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■ 通用型X7R、X5R、Z5U、Y5V可靠性測試方法

編號	項目	標準		測試方法
1	工作溫度範圍	X5R: -55°C ~ 85°C X7R: -55°C ~ 125°C	Z5U: 10°C ~ 85°C Y5V: -25°C ~ 85°C	
2	外觀	1. 瓷體顏色一致性好。 2. 芯片無可見損傷，光滑平整。 3. 瓷體無外露電極，裂痕，孔洞。 4. 端電極無裂痕，孔洞，磨損及表面氧化等。 5. 端電極應無延伸現象或延伸部分不超過端頭寬度的一半。		※ 在 ≥ 10 倍以上的顯微鏡下觀察。
3	尺寸	在規定尺寸範圍內		※ 使用千分尺或游標卡尺。
4	電容量	在規定偏差範圍內		※ 測試儀器: HP4278A 電橋、HP4284 電橋。 ※ 測試條件: 1. 測試溫度: 25°C ± 5°C, 濕度: 30% ~ 75%。 2. 測試電壓: 1.0 ± 0.2V, (Y5V) 0.5 ± 0.2V (Z5U)。 3. 測試頻率: 1.0 ± 0.1 KHz。
5	損耗因數(D.F.)	X5R, X7R Ur > 50V, Df < 250 × 10 ⁻⁴ Ur = 25V, 16V: Df < 350 × 10 ⁻⁴ Ur = 10V: Df < 500 × 10 ⁻⁴ Ur = 6.3V: C < 3.3uF, Df < 500 × 10 ⁻⁴ C > 3.3uF, DF < 1000 × 10 ⁻⁴	Z5U, Y5V Ur > 50V, DF < 500 × 10 ⁻⁴ Ur = 25V: C < 1.0 μF, DF < 700 × 10 ⁻⁴ C > 1.0 μF, DF < 900 × 10 ⁻⁴ Ur = 16V, 10V, 6.3V: DF < 1250 × 10 ⁻⁴	
6	絕緣電阻(I.R.)	C < 25nF, IR > 10000MΩ C > 25nF, R × C > 500S	C < 25nF, IR > 4000MΩ C > 25nF, R × C > 500S	※ 測試儀器: 絶緣電阻測試儀(如: SF2511 絶緣測試機)。 ※ 測試方法: 施加額定工作電壓, 在 60 ± 5 秒內測量絕緣電阻。
7	耐電壓強度	> 3 × 額定工作電壓		※ 施加 3 倍額定工作電壓, 持續 60 ± 1 秒, 未出現擊穿現象並且充電 / 放電電流低於 50mA。
8	電容量溫度特性	在工作溫度範圍內符合電容器特性溫度系數要求		※ 首先進行預處理: 進行 150+0/-10°C 熱處理 60 ± 5 分鐘, 然後在室溫條件下放置 24 ± 2 小時。 ※ 在 -55 ~ 125°C 或者 -55 ~ 85°C (X7R, X5R); -25°C ~ 85°C + 10°C ~ 85°C (Y5V ~ Z5U) 範圍內測試電容量, 其電容值相對於 25°C 時數值的變化率應在規定範圍內。
9	可焊性	75% 端電極覆蓋錫		※ 將電容器浸在乙醇和松香溶液中。 然後浸入有鉛 235 ± 5°C (無鉛 245 ± 5°C) 的混合焊錫溶液 2 ± 0.5 秒。 浸入速度: 25 ± 2.5mm/秒。

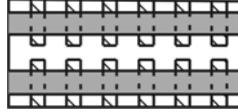


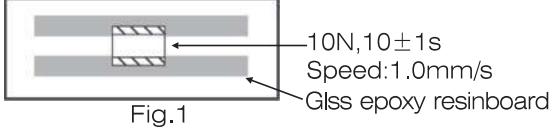
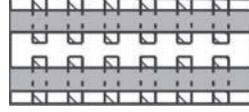
- X7R、X5R、Z5U、Y5V MLCC for general use reliability test method

Number	Item	Standard		Test Method
1	Operating Temperature Range	X5R: -55°C ~ 85°C X7R: -55°C ~ 125°C	Z5U: 10°C ~ 85°C Y5V: -25°C ~ 85°C	
2	Appearance	1.Good ceramic body color continuity. 2.The chips have no visual damages and must be very smooth. 3.No exposed inner- electrode, no cracks or holes. 4.The outer electrode should have no cracks, holes, damages or surface oxidation. 5.Outer electrode no prolongation or the prolongation is less than half of that of the termination width.		※Check by using microscope >10x.
3	Dimensions	Within the specified dimensions		※Using micrometer or vernier calipers
4	Capacitance)	Within the specified tolerance		※Measuring Equipments: HP4278 capacitance meter, HP4284 capacitance, ※Measuring Conditions: 1.Measuring Temperature: 25°C ± 5°C. Humidity: 30% ~ 75%. 2.Measuring Voltage: 1.0 ± 0.2V. 3.Measuring Frequency: 1.0 ± 0.1MHz
5	Dissipation Factor (DF)	X5R,X7R Ur > 50V, DF < 250 × 10 ⁻⁴ Ur=25V,16V: DF < 350 × 10 ⁻⁴ Ur=10V: DF < 500 × 10 ⁻⁴ Ur=6.3V: C < 3.3uF, DF < 500 × 10 ⁻⁴ C ≥ 3.3uF, DF < 1000 × 10 ⁻⁴	Z5U,Y5V Ur=50V,DF < 500 × 10 ⁻⁴ Ur=25V: C<1.0 μ F,DF < 700 × 10 ⁻⁴ C > 1.0 μ F,DF < 900 × 10 ⁻⁴ Ur=16V、10V、6.3V: DF < 1250 × 10 ⁻⁴	
6	Insulation Resistance	C < 25nF,IR > 10000MΩ C > 25nF,R × C > 500S	C < 25nF,IR > 40000MΩ 1C > 25nF,R × C > 500S	※Measuring Equipment: Insulation resistance meter (such as Sf2511 insulation resistance). ※Measuring Method: Must measure at rated voltage, and measure the IR within 60 ± 5 seconds.
7	Withstanding Voltage	>3Ur		※Must measure at 3 times rated voltage, dwell time: 60 ± 1 seconds, no short and the changing/discharging current less than 50mA.
8	Capacitance Temperature Characteristic	Must meet the capacitor character temperature coefficient requirements within the operating temperature range.		※First, pre-heat: heat treat 60 ± 5 minutes at 150+0/-10°C, then set it for 24 ± 2 hours at room temperature. ※Measure the capacitance at -55 ~ 125°C or -55 ~ 85°C, the capacitance change ratio comparing to that of 25°C must be within the specified range.
9	Solderability	Tin coverage should be 75% of the outer electrode		※Dip the capacitor into ethanol or colophony solution, and then dip it into 245 ± 5°C eutectic solder solution for 2 ± 0.5 seconds. Dipping speed: 25 ± 2.5mm/second.

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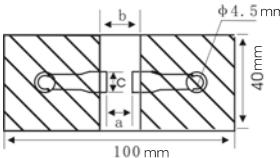
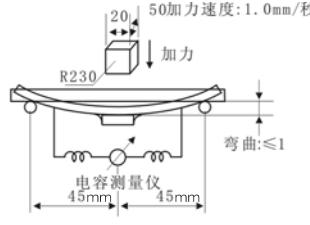
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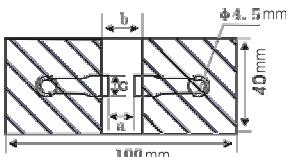
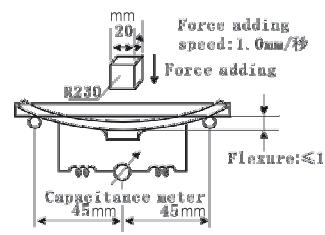
編號	項目	標準		測試方法									
10	耐焊接熱	外觀	無明顯缺陷	<p>※首先進行預處理：進行 $150+0/-10^{\circ}\text{C}$ 熱處理 60 ± 5 分鐘，然後在室溫條件下放置 24 ± 2 小時。</p> <p>※然後按下表預熱電容器。將電容器浸入 $265 \pm 5^{\circ}\text{C}$ 的混合焊錫溶液 10 ± 1 秒。再在室溫條件下放置 24 ± 2 小時，然後進行測量。</p> <p>浸入速度：$25 \pm 2.5\text{mm}/\text{秒}$。</p> <p>※預熱條件如下：</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>階段</th><th>溫度</th><th>時間</th></tr> </thead> <tbody> <tr> <td>1</td><td>$100^{\circ}\text{C} - 120^{\circ}\text{C}$</td><td>1分鐘</td></tr> <tr> <td>2</td><td>$170^{\circ}\text{C} - 200^{\circ}\text{C}$</td><td>1分鐘</td></tr> </tbody> </table>	階段	溫度	時間	1	$100^{\circ}\text{C} - 120^{\circ}\text{C}$	1分鐘	2	$170^{\circ}\text{C} - 200^{\circ}\text{C}$	1分鐘
階段	溫度	時間											
1	$100^{\circ}\text{C} - 120^{\circ}\text{C}$	1分鐘											
2	$170^{\circ}\text{C} - 200^{\circ}\text{C}$	1分鐘											
電容量變化率	X7R, X5R: 在 20% 範圍內 Z5U, Y5V: 在 30% 範圍內												
D.F.	同初始標準												
I.R.	同初始標準												
11	端電極結合強度	不應出現端電極脫落或其它缺陷。		<p>※使用混合焊錫將電容器焊接在圖 1 中所示的測試夾具（玻璃環氧樹脂板）上。然後沿箭頭方向施加 10N 的力。焊接應利用烙鐵或使用回流焊方法進行，而且應謹慎作業，以使焊接均勻且不會出現熱衝擊等不良現象。</p>  <p>圖1</p>									
12	耐振動性	外觀	無缺陷或異常	<p>※將電容器焊接在測試夾具（玻璃環氧樹脂板）上。電容器應進行簡諧運動，其總幅值為 1.5mm，頻率在近似 $10 - 55\text{Hz}$ 之間均勻變化。頻率範圍（從 10 至 55Hz 再返回 10Hz）應在約 1 分鐘內完成。振動應在三個相互垂直方向各進行 2 小時（總計 6 小時）。</p>  <p>圖2</p>									
		電容量	在規定偏差範圍內										
		D.F.	同初始標準										
13	抗彎曲性能	不應出現裂痕或其他缺陷		<p>※使用混合焊錫將電容器焊接在圖 3 中所示的測試夾具（玻璃環氧樹脂板）上，然後在圖 4 所示的方向加力。焊接應利用烙鐵或使用回流焊方法進行，而且應謹慎作業，以使焊接均勻且不會出現熱衝擊等不良現象。</p>									

Number	Item	Standard	Test Method									
10	Resistance to Soldering	Appearance	No defects visible									
		Cap. Change ratio	X7R, X5R: within 20% Z5U, Y5V: within 30%									
		DF	Same as original spec.									
		IR	Same as original spec.									
			<p>※First pre-heat: heat treat for 60 ± 5 minutes at $150+0/-10^\circ\text{C}$, then set it for 24 ± 2 hours at room temperature.</p> <p>※Then pre-heat the capacitance according to the following chart. Dip the capacitor into $265 \pm 5^\circ\text{C}$ eutectic solder solution for 10 ± 1s. Then set it for 24 ± 2 hours at room temperature, then measure. Dipping speed: $25 \pm 2.5\text{mm/second}$.</p> <p>※Preheat conditions:</p> <table border="1"> <thead> <tr> <th>Stage</th><th>Temperature</th><th>Time</th></tr> </thead> <tbody> <tr> <td>1</td><td>$100^\circ\text{C} - 120^\circ\text{C}$</td><td>1 minute</td></tr> <tr> <td>2</td><td>$170^\circ\text{C} - 200^\circ\text{C}$</td><td>1 minute</td></tr> </tbody> </table>	Stage	Temperature	Time	1	$100^\circ\text{C} - 120^\circ\text{C}$	1 minute	2	$170^\circ\text{C} - 200^\circ\text{C}$	1 minute
Stage	Temperature	Time										
1	$100^\circ\text{C} - 120^\circ\text{C}$	1 minute										
2	$170^\circ\text{C} - 200^\circ\text{C}$	1 minute										
11	Adhesive Strength of Termination	No removal of the terminations or other defect shall occur	<p>※Solder the capacitor to the test jig (glass epoxy resin board) shown in Fig.1 using a eutectic solder. Then apply a 10N force in the direction shown as the arrowhead. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock, etc.</p>  <p>Fig.1</p>									
12	Resistance to Vibration	Appearance	No defects or abnormalities									
		Capacitance	Within the specified tolerance range									
		D.F.	Same as original spec.									
			<p>※Solder the capacitor to the test jig (glass epoxy resin board). The capacitor should be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz, shall be traversed (from 10 Hz to 55 Hz then 10 Hz again) in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions (total is 6 hours).</p>  <p>Fif.2</p>									
13	Bending Resistance	No cracks or other defects shall occur	<p>※Solder the capacitor to the test jig (glass epoxy resin board) shown in Fig.3 using a eutectic solder. Then apply a 10N force in the direction shown as Fig.4. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock, etc.</p>									

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MULTILAYER CHIP CERAMIC CAPACITOR

編號	項目	標準	測試方法																						
13	抗彎曲性能		  <p>图3</p> <p>图4</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th rowspan="2">L×W (mm)</th> <th colspan="4">尺寸(mm)</th> </tr> <tr> <th>a</th> <th>b</th> <th>c</th> <th>d</th> </tr> </thead> <tbody> <tr> <td>4.5×2.0</td> <td>3.5</td> <td>7.0</td> <td>2.4</td> <td rowspan="3">1.0</td> </tr> <tr> <td>4.5×3.2</td> <td>3.5</td> <td>7.0</td> <td>3.7</td> </tr> <tr> <td>5.7×6.3</td> <td>4.5</td> <td>8.0</td> <td>5.6</td> </tr> </tbody> </table>	L×W (mm)	尺寸(mm)				a	b	c	d	4.5×2.0	3.5	7.0	2.4	1.0	4.5×3.2	3.5	7.0	3.7	5.7×6.3	4.5	8.0	5.6
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	a	b	c	d																					
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14	溫度循環	外觀 無缺陷或異常 電容量變化率 X7R, X5R: 在 ±20%範圍內 Z5U, Y5V: 在 ±30%範圍內 D.F. 同初始標準 I.R. 同初始標準	<table border="1" style="width: 100%;"> <thead> <tr> <th>階段</th> <th>溫度(°C)</th> <th>時間(分鐘)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>最低工作溫度 ± 3</td> <td>30 ± 3</td> </tr> <tr> <td>2</td> <td>常溫</td> <td>2—3</td> </tr> <tr> <td>3</td> <td>最高工作溫度 ± 2</td> <td>30 ± 3</td> </tr> <tr> <td>4</td> <td>常溫</td> <td>2—3</td> </tr> </tbody> </table>	階段	溫度(°C)	時間(分鐘)	1	最低工作溫度 ± 3	30 ± 3	2	常溫	2—3	3	最高工作溫度 ± 2	30 ± 3	4	常溫	2—3							
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16	濕度負荷	外觀 無缺陷或異常 電容量變化率 X7R, X5R: 在 ±20%範圍內 Z5U, Y5V: 在 ±30%範圍內 D.F. 同初始標準 I.R 同初始標準	※在 40 ± 2°C 和 90—95% 相對濕度條件下施加額定電壓 500+24/-0小時。然后將其移動到室溫條件下放置 48 ± 2 小時，進行測量。																						
17	壽命	外觀 無缺陷或異常 電容量變化率 X7R, X5R: 在 ±20%範圍內 Z5U, Y5V: 在 ±30%範圍內 D.F. 同初始標準 I.R 同初始標準	※在上限溫度下施加2倍的額定工作電壓1000 ± 12小時，充放電電流不超過50mA。將其移動到室溫條件下恢復放置 48 ± 2 小時，進行測量。																						

Number	Item	Standard	Test Method																								
13	Bending Resistance		  <p>Fig. 3 Fig. 4</p> <table border="1"> <thead> <tr> <th>L×W (mm)</th> <th colspan="3">Dimension</th> </tr> <tr> <th></th> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td>4.5×2.0</td> <td>3.5</td> <td>7.0</td> <td>2.4</td> </tr> <tr> <td>4.5×3.2</td> <td>3.5</td> <td>7.0</td> <td>3.7</td> </tr> <tr> <td>5.7×6.3</td> <td>4.5</td> <td>8.0</td> <td>5.6</td> </tr> <tr> <td></td> <td></td> <td></td> <td>1.0</td> </tr> </tbody> </table>	L×W (mm)	Dimension				a	b	c	4.5×2.0	3.5	7.0	2.4	4.5×3.2	3.5	7.0	3.7	5.7×6.3	4.5	8.0	5.6				1.0
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14	Temperature Cycle	Appearance: No defects Cap. Change ratio: X7R, X5R: within ±20%; Z5U, Y5V: within ±30% D.F.: Same as original standard I.R.: same as original standard	<table border="1"> <thead> <tr> <th>Stage</th> <th>Temperature (°C)</th> <th>Time (min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>Min. Operating Temperature±3</td> <td>30±3</td> </tr> <tr> <td>2</td> <td>Room Temperature</td> <td>2—3</td> </tr> <tr> <td>3</td> <td>Max. Operating Temperature 2</td> <td>30±3</td> </tr> <tr> <td>4</td> <td>Room Temperature</td> <td>2—3</td> </tr> </tbody> </table>	Stage	Temperature (°C)	Time (min.)	1	Min. Operating Temperature±3	30±3	2	Room Temperature	2—3	3	Max. Operating Temperature 2	30±3	4	Room Temperature	2—3									
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15	Humidity Steady State	Appearance: No defects Cap. Change ratio: X7R, X5R: within ±20%; Z5U, Y5V: within ±30% D.F.: Same as original standard I.R.: Same as original standard	※ Set the capacitor for 500+24/-0 hours at the condition of 40±2°C and 90-95% humidity. Then remove and set it for 48±2 hours at room temperature, then measure.																								
16	Humidity Load	Appearance: No defects Cap. Change ratio: X7R, X5R: within ±20%; Z5U, Y5V: within ±30% D.F.: Same as original standard I.R.: Same as original standard	※ Apply rated voltage to the capacitor for 500+24/-0 hours at the condition of 40±2°C and 90-95% humidity. Remove and set it for 48±2 hours at room temperature, then measure.																								
17	Life Test	Appearance: No defects Cap. Change ratio: X7R, X5R: within ±20%; Z5U, Y5V: within ±30% D.F.: Same as original standard I.R.: Same as original standard	※ Apply two times rated voltage to the capacitor for 1000±12 hours at the upper temperature limits, the charging current should be less than 50mA. Remove and set it for 24 2 hours at room temperature, then measure.																								

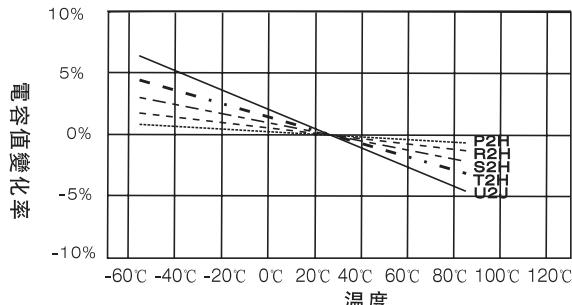
多層片式陶瓷電容器

MULTILAYER CHIP CERAMIC CAPACITOR

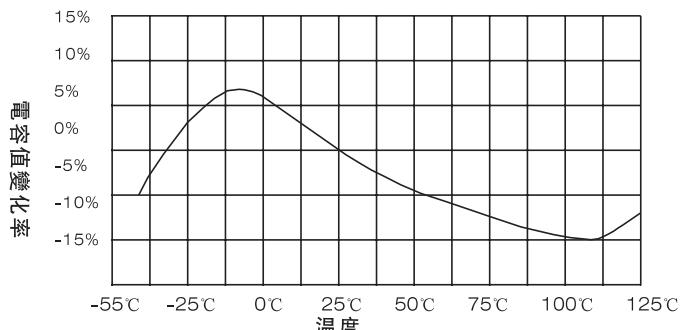
■ 通用型片容特性曲線

- COG和PH、RH、SH、TH、UH系列

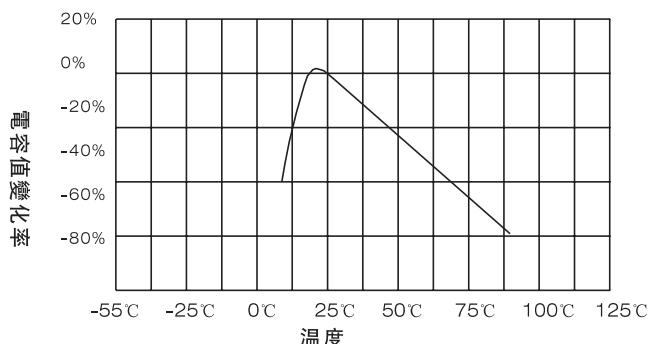
溫度系數圖



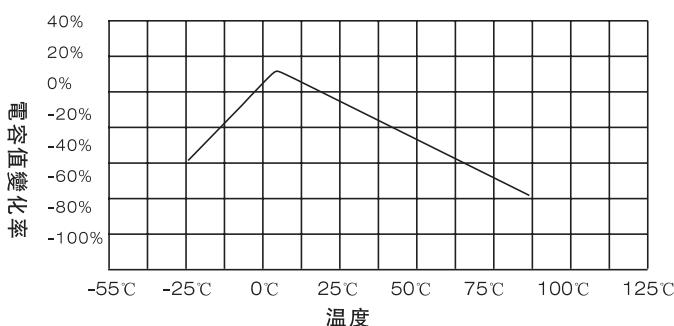
X7R溫度特性



Z5U溫度特性

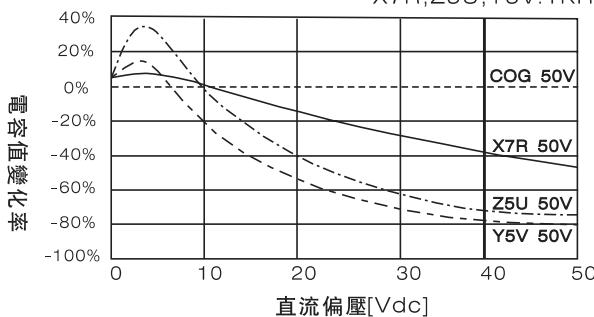


Y5V溫度特性



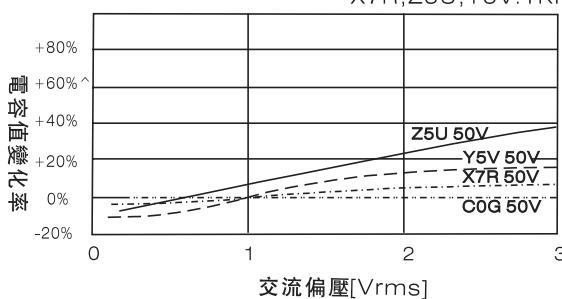
● 電容器偏壓特性圖

測量條件: COG :1MHZ
X7R,Z5U,Y5V:1KHZ

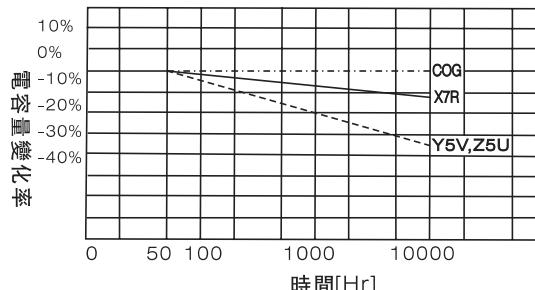


● 電容器交流電壓特性圖

測量條件: COG :1MHZ
X7R,Z5U,Y5V:1KHZ



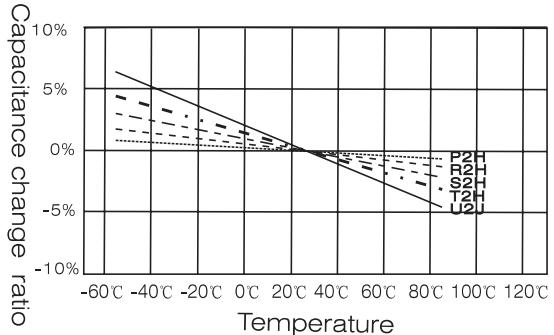
● 電容器老化特性圖



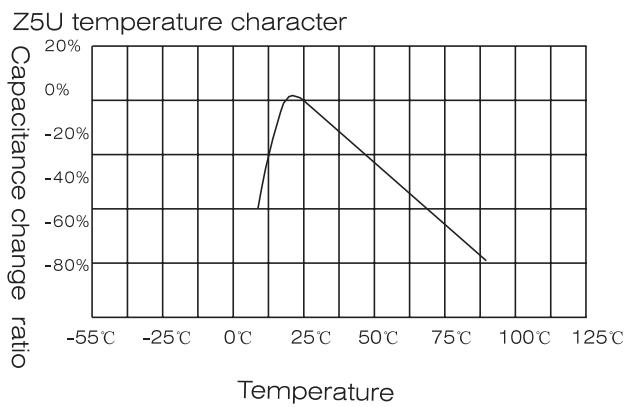
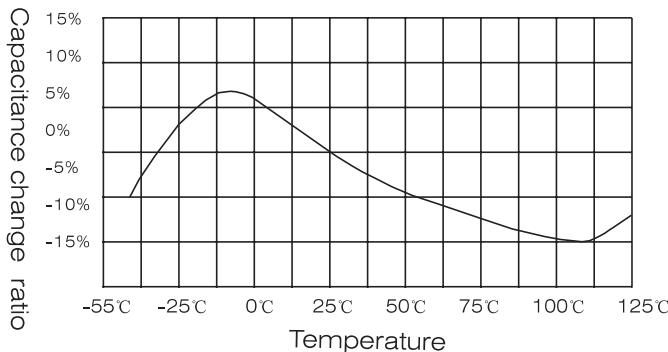


■ GENEREL-USE MLCC CHARCCTER PROFILES

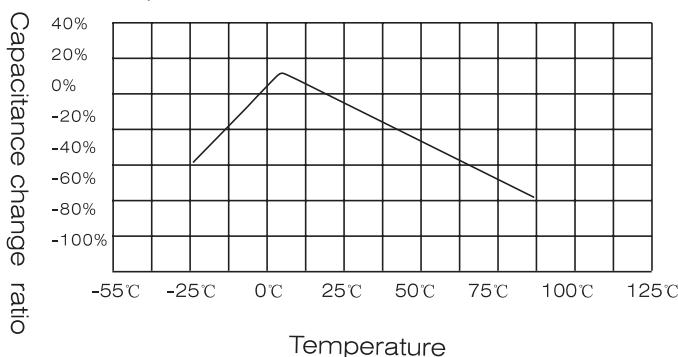
- COG and PH、RH、SH、TH、UH series temperature coefficient



X7R tempreture characteristics

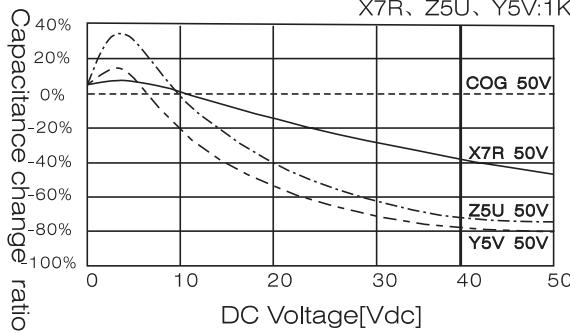


Y5V temperature characteristics



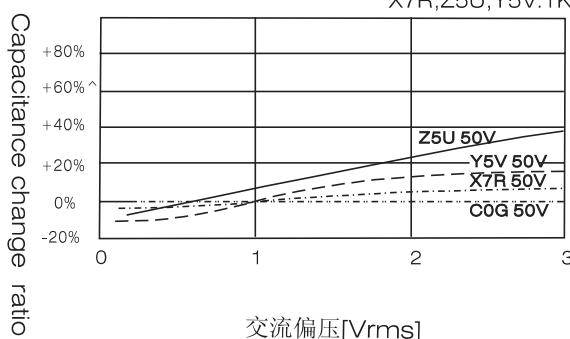
- DC Voltage Characteristics

Measuring condition COG :1MHz
X7R, Z5U, Y5V:1KHz

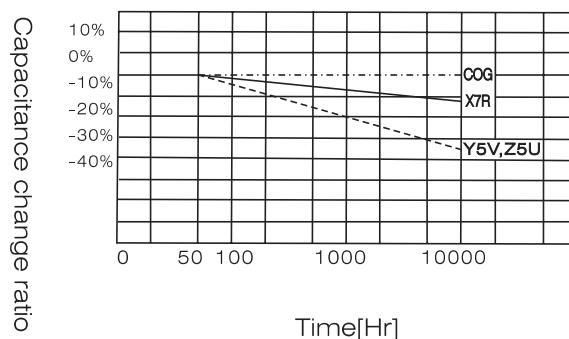


- Capacitance-AC Voltage Characteristics

Measuring condition: COG :1MHz
X7R,Z5U,Y5V:1KHz



- Capacitance change aging

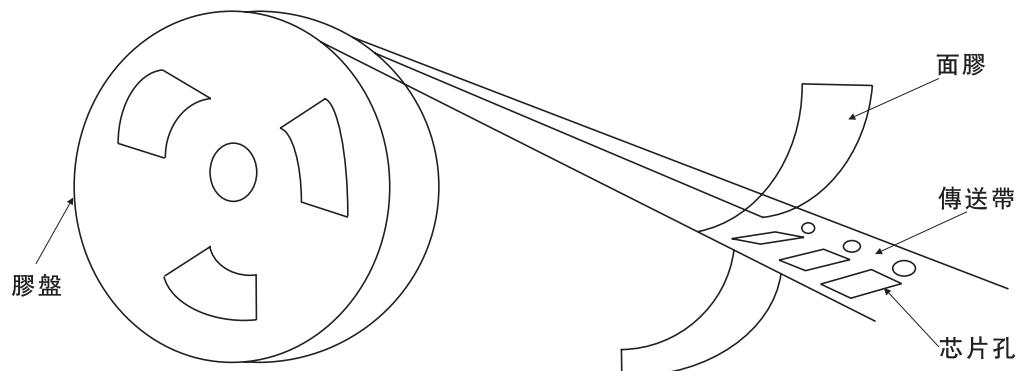


多層片式陶瓷電容器

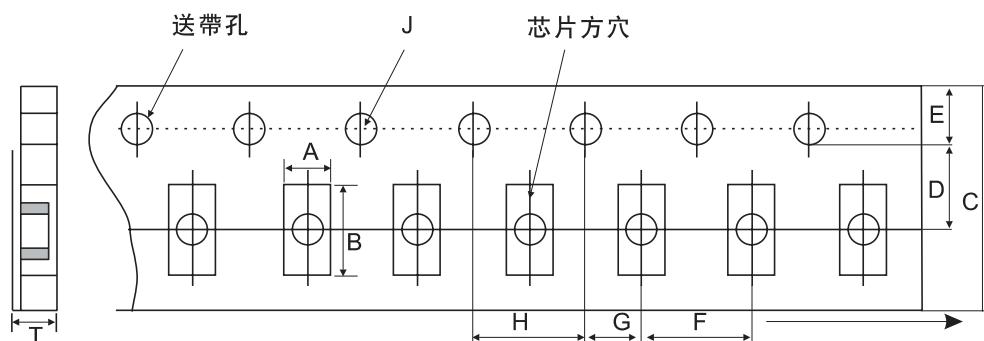
MULTILAYER CHIP CERAMIC CAPACITOR

■ 包裝

- 紙帶卷盤結構



* 適合 0402,0603, 0805, 1206 常規尺寸產品的紙帶尺寸

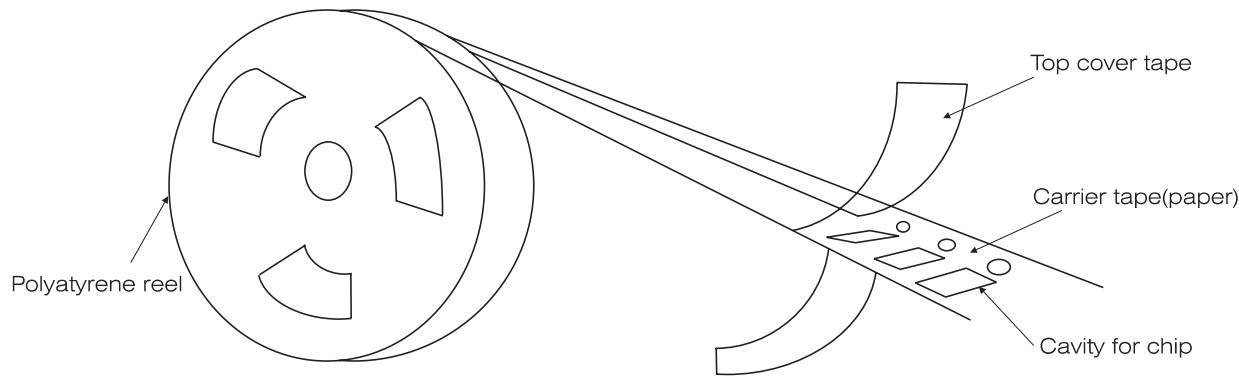


代號 紙帶規格	A	B	C	D	E	F	G	H	J	T*
0402	0.65 ± 0.10	1.15 ± 0.10	8.00 ± 0.10	3.50 ± 0.05	1.75 ± 0.10	2.00 ± 0.05	2.00 ± 0.05	4.00 ± 0.10	1.50-0/ +0.10	低于 0.80
0603	1.10 ± 0.20	1.90 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	低于 1.10
0805	1.45 ± 0.20	2.30 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	低于 1.10
1206	1.80 ± 0.20	3.40 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	低于 1.10

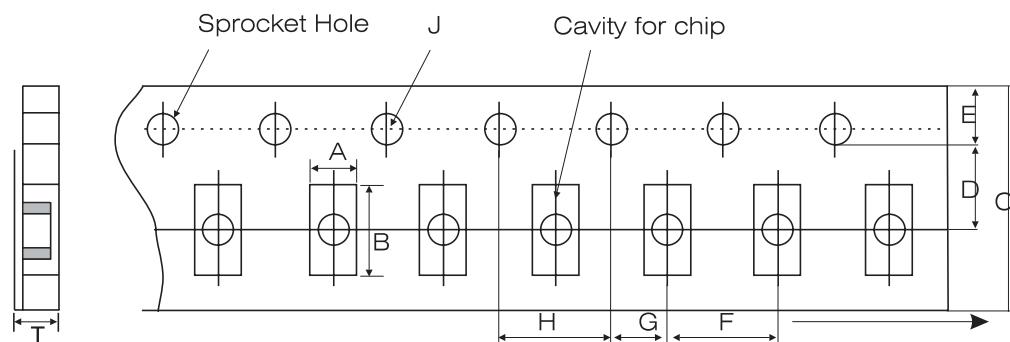


■ Package

- Paper Tape Taping



※Dimensions of paper take taping for 0402, 0603, 0805, 1206



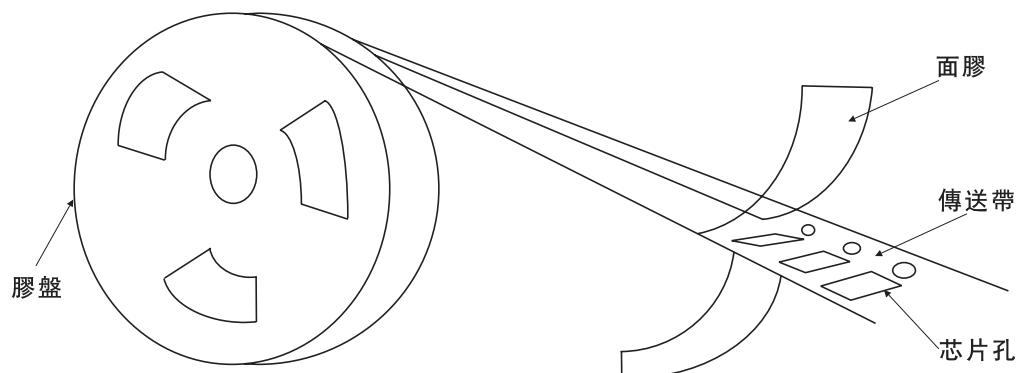
Code Paper size \	A	B	C	D	E	F	G	H	J	T *
0402	0.65 ± 0.10	1.15 ± 0.10	8.00 ± 0.10	3.50 ± 0.05	1.75 ± 0.10	2.00 ± 0.05	2.00 ± 0.05	4.00 ± 0.10	1.50-0/ +0.10	Below 0.80
0603	1.10 ± 0.20	1.90 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	Below 1.10
0805	1.45 ± 0.20	2.30 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	Below 1.10
1206	1.80 ± 0.20	3.40 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	Below 1.10

多層片式陶瓷電容器

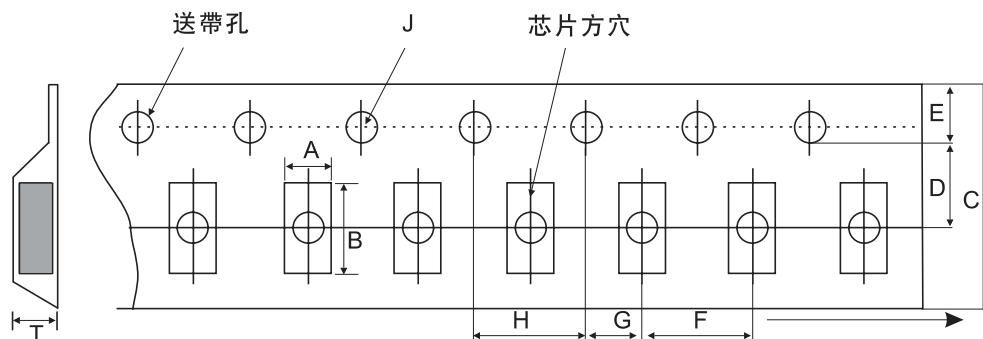
MULTILAYER CHIP CERAMIC CAPACITOR

■ 包裝

- 紙帶卷盤結構



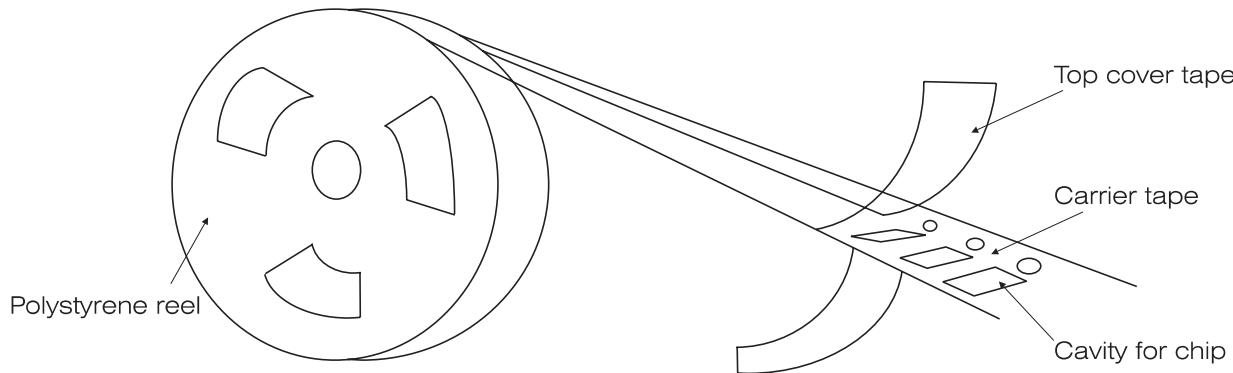
* 适合0805, 1206, 1210, 1808, 1812常规尺寸产品的塑胶带尺寸



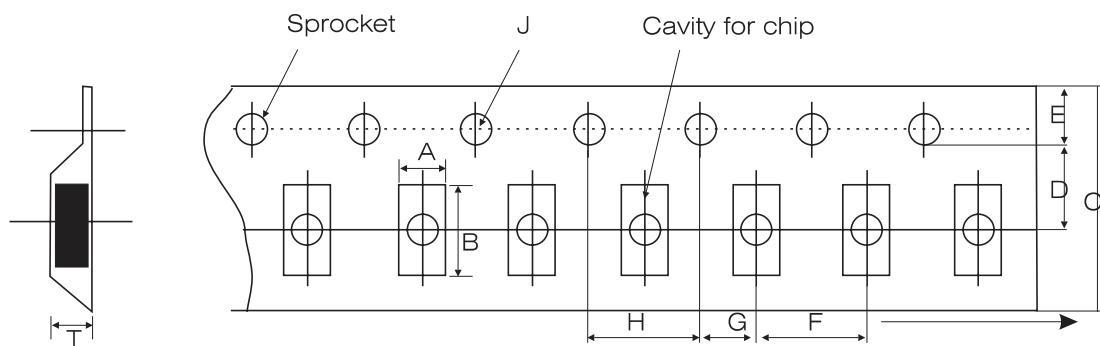
代號 紙帶規格	A	B	C	D	E	F*	G	H	J	T
0805	1.55 ± 0.20	2.35 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	低于 1.50
1206	1.95 ± 0.20	3.60 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	低于 1.85
1210	2.70 ± 0.10	3.42 ± 0.10	8.00 ± 0.10	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	1.50-0/ +0.10	低于 3.2
1808	2.20 ± 0.10	4.95 ± 0.10	12.00 ± 0.10	5.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	1.50-0/ +0.10	低于 3.0
1812	3.66 ± 0.10	4.95 ± 0.10	12.00 ± 0.10	5.50 ± 0.05	1.75 ± 0.10	8.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	1.50-0/ +0.10	低于 4.0

注意:*表示此處對尺寸的要求非常精確

- Embossed Taping



※Dimensions of embossed taping for 0805, 1206, 1210, 1808, 1812 type



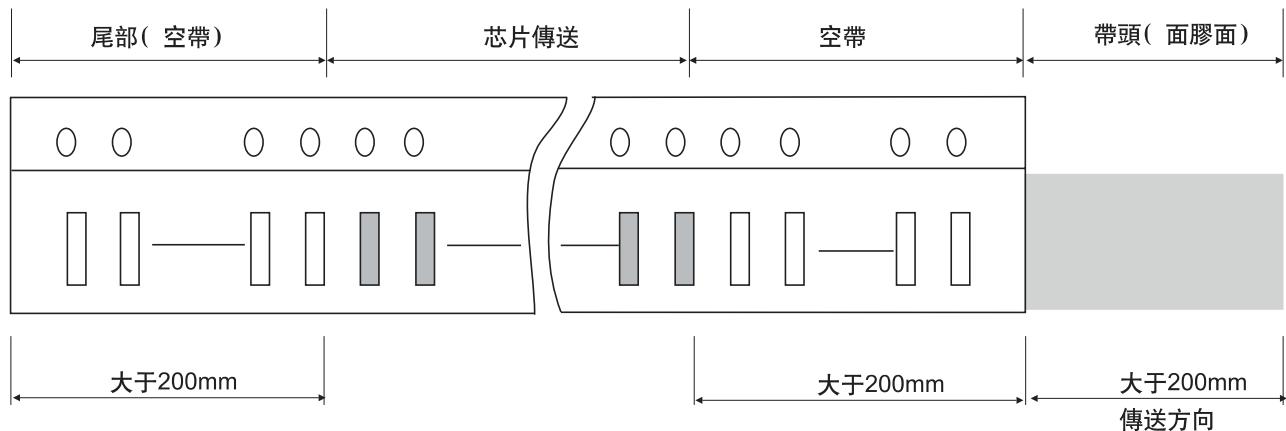
Code Tape size	A	B	C	D	E	F*	G	H	J	T
0805	1.55 ± 0.20	2.35 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	低于 1.50
1206	1.95 ± 0.20	3.60 ± 0.20	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	4.00 ± 0.10	1.50-0/ +0.10	低于 1.85
1210	2.70 ± 0.10	3.42 ± 0.10	8.00 ± 0.10	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	1.50-0/ +0.10	低于 3.2
1808	2.20 ± 0.10	4.95 ± 0.10	12.00 ± 0.10	5.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	1.50-0/ +0.10	低于 3.0
1812	3.66 ± 0.10	4.95 ± 0.10	12.00 ± 0.10	5.50 ± 0.05	1.75 ± 0.10	8.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	1.50-0/ +0.10	低于 4.0

Note: The place with "*" means where needs exactly dimensions.

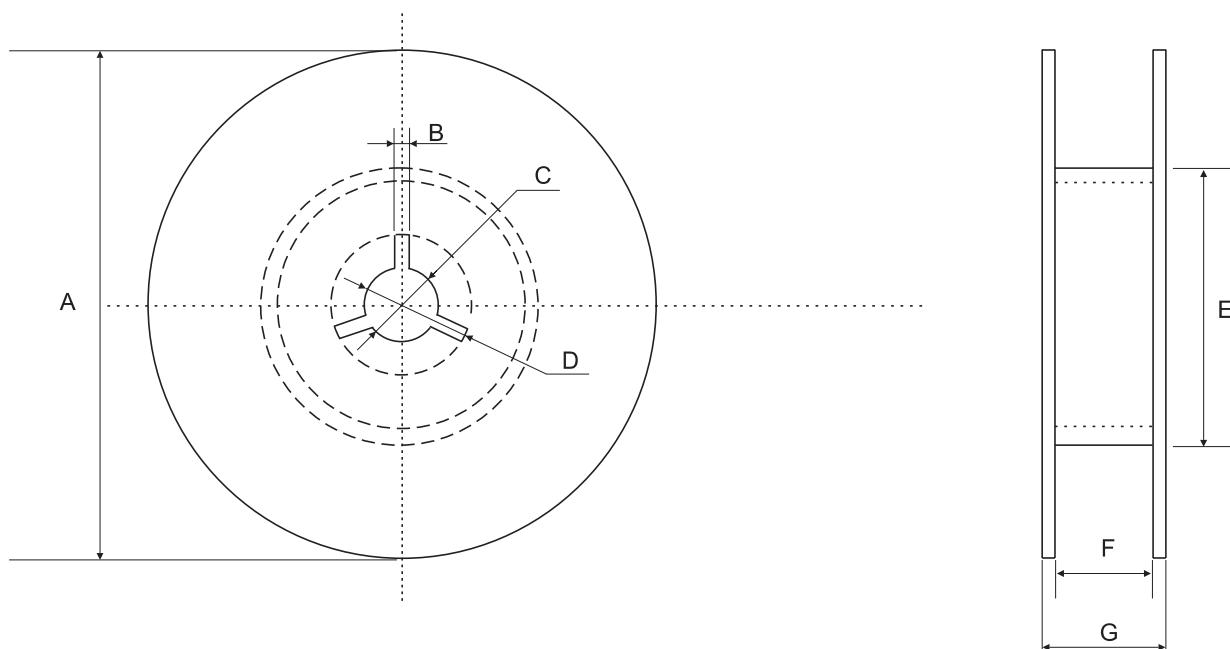
多層片式陶瓷電容器

MULTILAYER CHIP CERAMIC CAPACITOR

- 傳送帶的前后結構



- 卷盤尺寸(單位:mm)

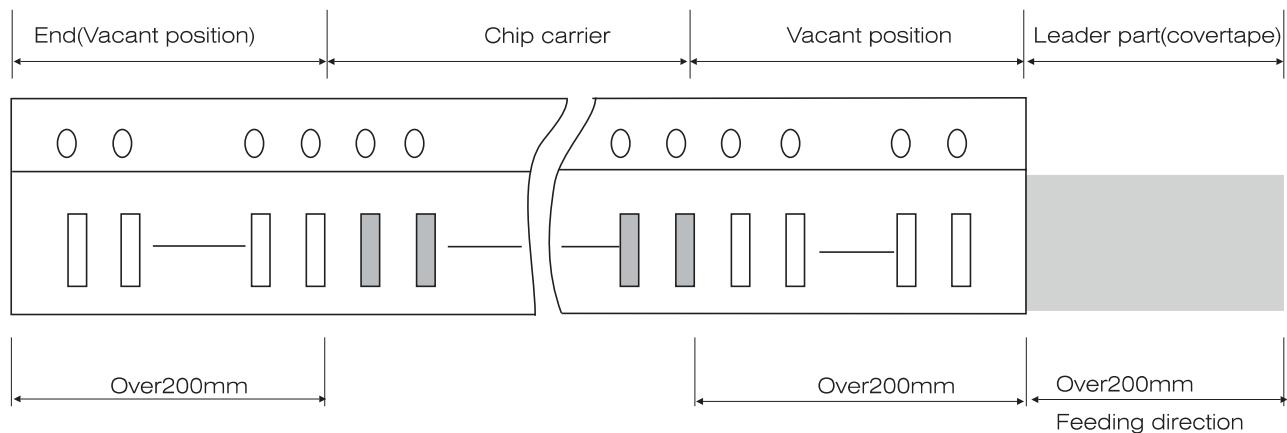


- 尺寸代碼

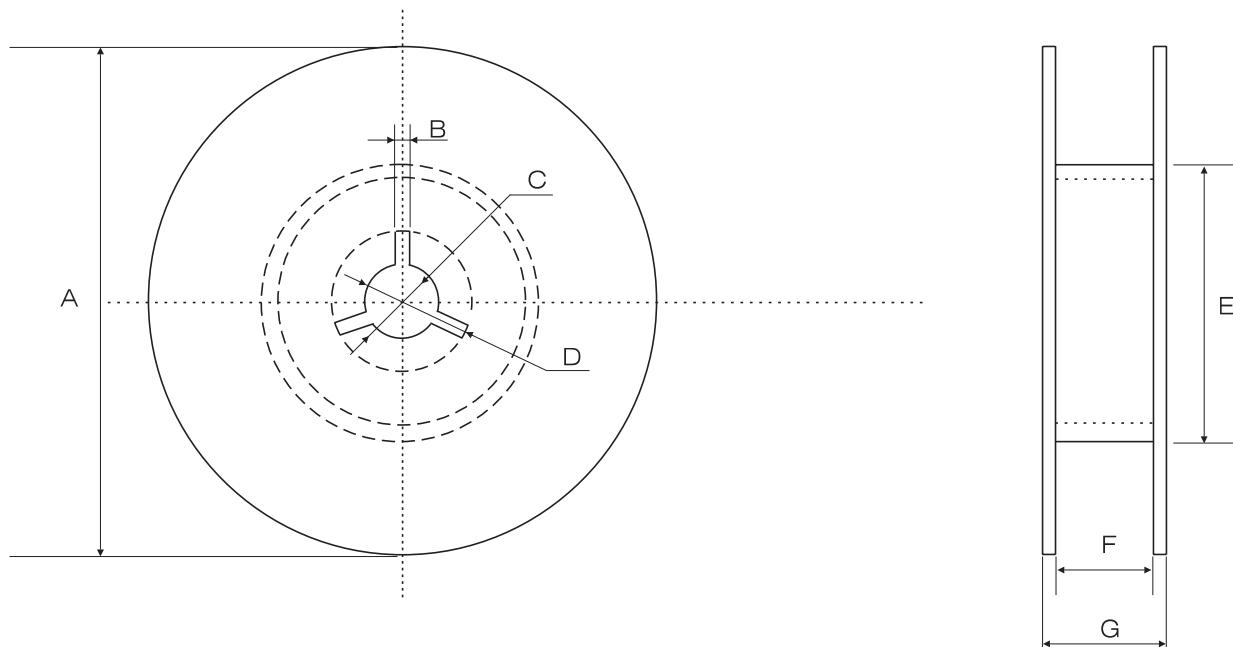
A	B	C	D	E	F	G
$\Phi 178.00 \pm 2.00$	3.00	$\Phi 13.00 \pm 0.50$	$\Phi 21.00 \pm 0.80$	$\Phi 50.00$ 或更大	10.00 ± 1.50	12MAX
$\Phi 330.00 \pm 2.00$	3.00	$\Phi 13.00 \pm 0.50$	$\Phi 21.00 \pm 0.80$	$\Phi 50.00$ 或更大	10.00 ± 1.50	12MAX



- Structure of leader part and end part of the carrier paper



- Reel Dimensions (unit:mm)



- Code

A	B	C	D	E	F	G
$\Phi 178.00 \pm 2.00$	3.00	$\Phi 13.00 \pm 0.50$	$\Phi 21.00 \pm 0.80$	$\Phi 50.00$ or max	10.00 ± 1.50	12MAX
$\Phi 330.00 \pm 2.00$	3.00	$\Phi 13.00 \pm 0.50$	$\Phi 21.00 \pm 0.80$	$\Phi 50.00$ or max	10.00 ± 1.50	12MAX

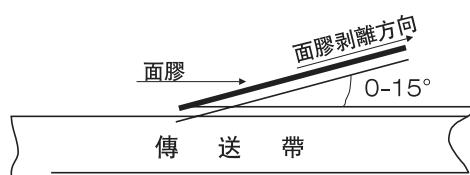
多層片式陶瓷電容器

MULTILAYER CHIP CERAMIC CAPACITOR

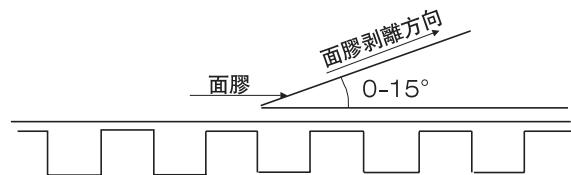
■ 關於卷帶的說明

- 面膠剝離強度

(A)紙帶



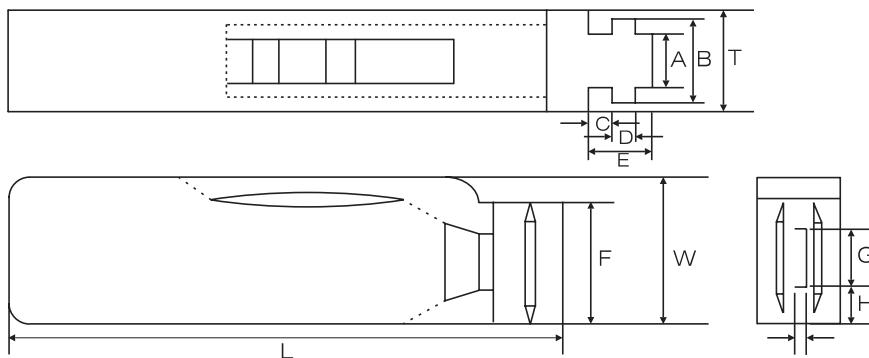
(B)塑料膠盤



標準: $0.1\text{N} < \text{剝離強度} < 0.7\text{N}$; 在剝離時, 紙帶不能有紙碎, 也不能粘在底、面膠上。

- 塑料盒散裝

標示	A	B	T	C	D	E
尺寸	6.80 ± 0.10	8.80 ± 1.00	12.00 ± 0.10	$15.00 +0.10/-0$	$2.00 \pm 0/-0.10$	4.70 ± 0.10
標示	F	W	G	H	L	I
尺寸	$31.50 +0.20/-0$	$36.00 +0/-0.2$	19.00 ± 0.35	7.00 ± 0.35	110.00 ± 0.70	5.00 ± 0.35



- 包裝數量

尺寸	包裝形式和數量			
	紙帶卷盤	膠帶卷盤	塑料盒散裝	一般散裝
0402	10000		20000	5000
0603	4000		15000	5000
0805	4000	3000	10000	5000
1206	4000	$T \leq 1.35\text{mm}$ 3000 $T > 1.35\text{mm}$ 2000	5000	5000
1210		$T \leq 1.80\text{mm}$ 2000 $T > 1.80\text{mm}$ 1000		2000
1808		2000		2000
1812		$T \leq 1.85\text{mm}$ 1000 $T > 1.85\text{mm}$ 500		2000
2225		500		500
3035		500		

注意: 包裝的形式和數量可根據客戶的要求來定。

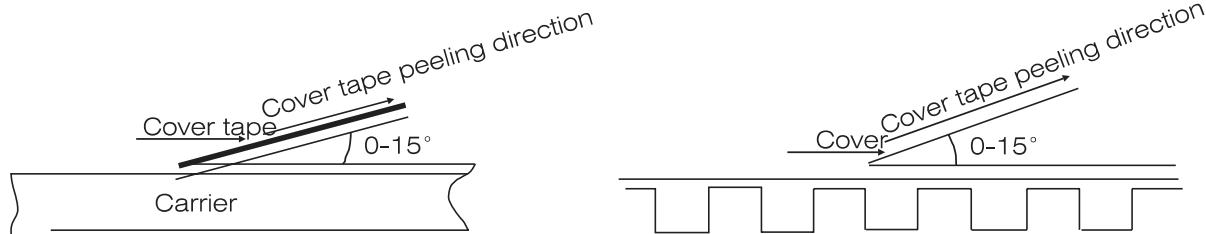


■ TAPING SPECIFICATION

- Top cover tape peeling strength

(A)Paper Taping

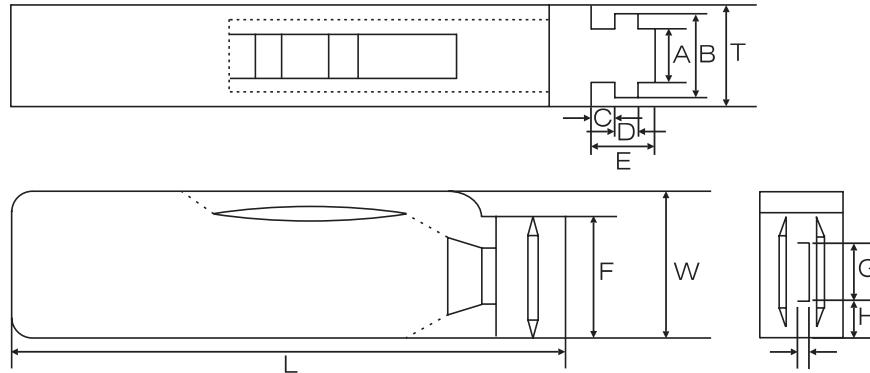
(b)Cover tape peeling direction

Standard: $0.1\text{N} < \text{peeling force} < 0.7\text{N}$;

No paper dirty remains on the scotch when peeling, and no sticks to top and bottom cover tape.

- Bulk Case Package

Symbol	A	B	T	C	D	E
Dimension	6.80 ± 0.10	8.80 ± 1.00	12.00 ± 0.10	$15.00 + 0.10 / -1$	$2.00 \pm 0 / -0.10$	4.70 ± 0.10
Symbol	F	W	G	H	L	I
Dimension	$31.50 + 0.20 / -0$	$36.00 + 0 / -0.2$	19.00 ± 0.35	7.00 ± 0.35	110.00 ± 0.70	5.00 ± 0.35



- Pack Quantity

Size	Pakaging method and quantity			
	Paper tape taping	Plastic embossed taping	Bulk plastic box packaging	Normal bulk packaging
0402	10000		20000	5000
0603	4000		15000	5000
0805	4000	3000	10000	5000
1206	4000	$T \leq 1.35\text{mm}$ 3000 $T > 1.35\text{mm}$ 2000	5000	5000
1210		$T \leq 1.80\text{mm}$ 2000 $T > 1.80\text{mm}$ 1000		2000
1808		2000		2000
1812		$T \leq 1.85\text{mm}$ 1000 $T > 1.85\text{mm}$ 500		2000
2225		500		500
3035		500		

Note: We can choose packing style and quantity can be according to the customer's requirement.